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New Approaches to Micropatterning, Volume II

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Message from the Guest Editors

In this Special Issue, we focus on new developments in micropatterning approaches, such as micropatterning within microfluidic devices, multiplexed micropatterning, patterning in three-dimensional structures, as well as new chemistries and materials, and the applications derived from them. We invite original research contributions, short communications, and in-depth reviews from early career and established researchers. The goal of this Special Issue is to capture the state-of-the-art in micropatterning techniques and the wide range of applications that these technologies can be deployed in. We look forward to and welcome your contributions to this Special Issue.













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Message from the Editor-in-Chief

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